

## Description

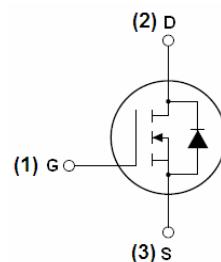
The VSM100N10 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

## General Features

- $V_{DS} = 100V, I_D = 100A$
- $R_{DS(ON)} < 13m\Omega @ V_{GS}=10V$  (Typ:9.9m $\Omega$ )
- Special process technology for high ESD capability
- High density cell design for ultra low  $R_{dson}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high  $E_{AS}$
- Excellent package for good heat dissipation

## Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Schematic Diagram

## Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VSM100N10-TC	VSM100N10	TO-220C	-	-	-

## Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current-Continuous	100	A
$I_D (100^\circ C)$	Drain Current-Continuous( $T_c=100^\circ C$ )	80	A
$I_{DM}$	Pulsed Drain Current	380	A
$P_D$	Maximum Power Dissipation	200	W
	Derating factor	1.33	W/ $^\circ C$
$E_{AS}$	Single pulse avalanche energy <sup>(Note 5)</sup>	800	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 175	$^\circ C$

### Thermal Characteristic

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	0.75	°C/W
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### Electrical Characteristics ( $T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	100	110	-	V
$I_{DS(on)}$	Zero Gate Voltage Drain Current	$V_{DS}=100V, V_{GS}=0V$	-	-	1	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
<b>On Characteristics</b> <sup>(Note 3)</sup>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2	3	4	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=40A$	-	9.9	13	$m\Omega$
$G_{FS}$	Forward Transconductance	$V_{DS}=50V, I_D=40A$	100	-	-	S
<b>Dynamic Characteristics</b> <sup>(Note 4)</sup>						
$C_{iss}$	Input Capacitance	$V_{DS}=50V, V_{GS}=0V, F=1.0MHz$	-	4800	-	PF
$C_{oss}$	Output Capacitance		-	340	-	PF
$C_{rss}$	Reverse Transfer Capacitance		-	150	-	PF
<b>Switching Characteristics</b> <sup>(Note 4)</sup>						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=50V, I_D=40A, V_{GS}=10V, R_{GEN}=2.5\Omega$	-	15	-	nS
$t_r$	Turn-on Rise Time		-	50	-	nS
$t_{d(off)}$	Turn-Off Delay Time		-	40	-	nS
$t_f$	Turn-Off Fall Time		-	55	-	nS
$Q_g$	Total Gate Charge	$V_{DS}=80V, I_D=40A, V_{GS}=10V$	-	85	-	nC
$Q_{gs}$	Gate-Source Charge		-	18	-	nC
$Q_{gd}$	Gate-Drain Charge		-	28	-	nC
<b>Drain-Source Diode Characteristics</b>						
$V_{SD}$	Diode Forward Voltage <sup>(Note 3)</sup>	$V_{GS}=0V, I_S=40A$	-	-	1.2	V
$I_S$	Diode Forward Current <sup>(Note 2)</sup>	-	-	-	57	A
$t_{rr}$	Reverse Recovery Time	$T_J = 25^\circ C, IF = 40A$ $di/dt = 100A/\mu s$ (Note3)	-	38	80	nS
$Q_{rr}$	Reverse Recovery Charge		-	53	100	nC
$t_{on}$	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

### Notes:

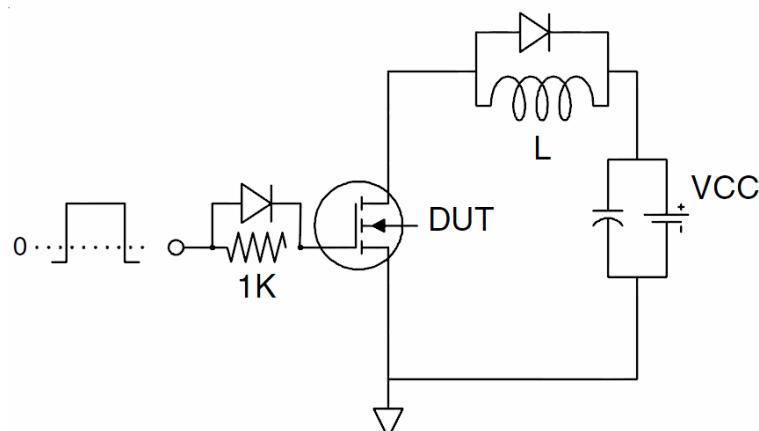
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production
5. EAS condition:  $T_j=25^\circ C, V_{DD}=50V, V_G=10V, L=0.5mH, R_g=25\Omega$

## Test Circuit

### 1) E<sub>AS</sub> test Circuit



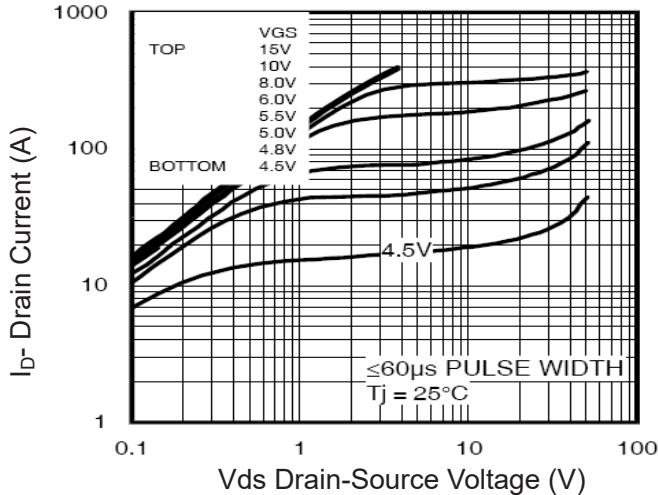
### 2) Gate charge test Circuit



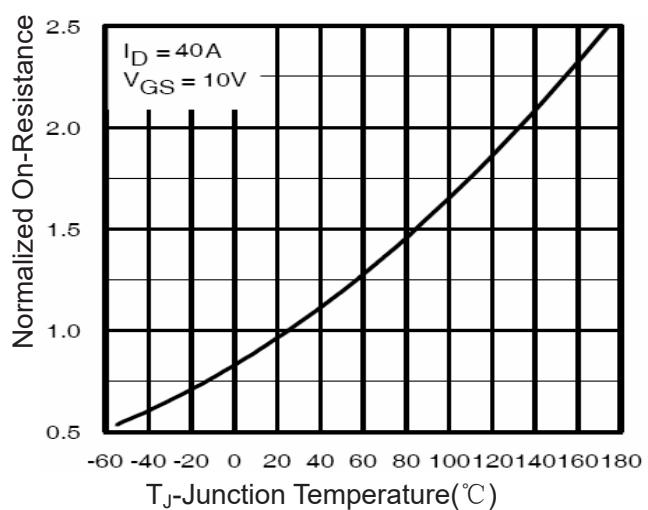
### 3) Switch Time Test Circuit



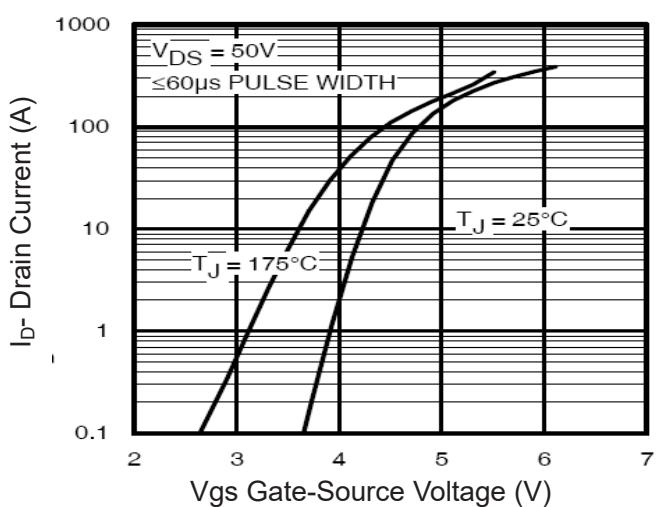
## Typical Electrical and Thermal Characteristics (Curves)



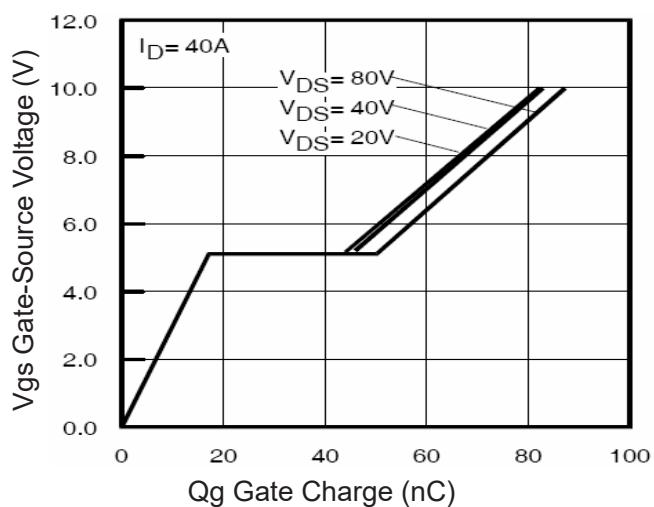
**Figure 1 Output Characteristics**



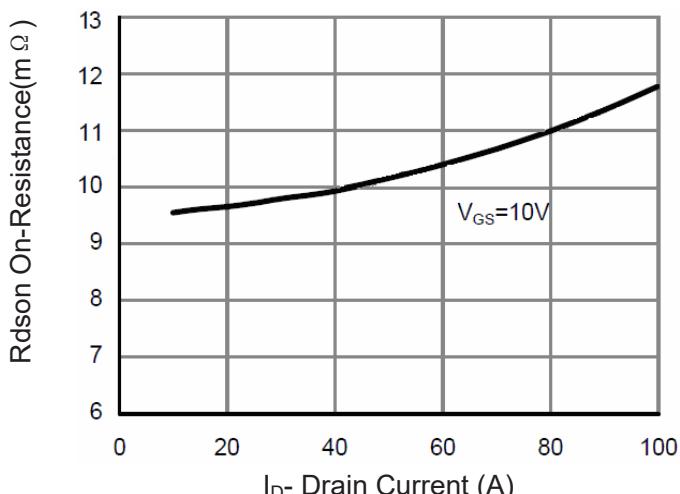
**Figure 4 Rdson-JunctionTemperature**



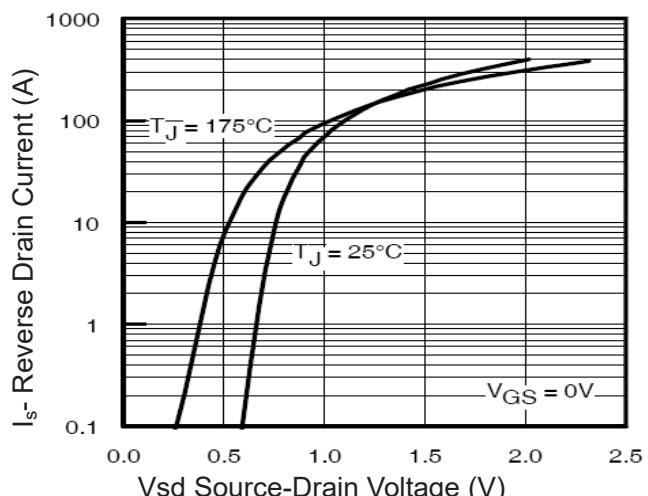
**Figure 2 Transfer Characteristics**



**Figure 5 Gate Charge**



**Figure 3 Rdson- Drain Current**



**Figure 6 Source- Drain Diode Forward**

